

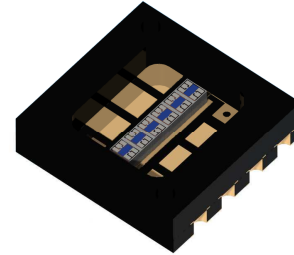
General Description

OIT24C consists in a silicon phototransistor's monolithic array.

The phototransistors have a common collector, every emitter is available as a pad. The pitch of the silicon arrays is 0.6 mm, while the component electrical pitch is 1.27 mm. The active area of each element is 0.2 x 0.45 mm. The encapsulant is an high quality microelectronic transparent resin, its transmission value is 100% in the range 300-900nm.

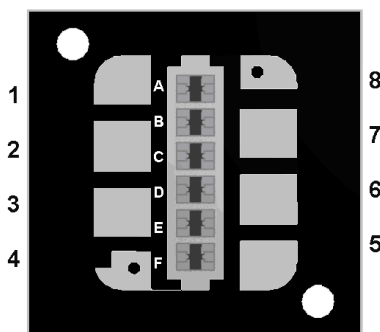
The advantages of this product are the high uniformity of the silicon sensors, due to the monolithic construction and the high optical responsivity, due to the antireflective coating deposited on the phototransistor's areas.

The packaging method is oriented to industrial harsh applications, which means high temperature range, high stability in time and very high uniformity of the silicon cells.



Applications

Optical encoders
Incremental encoders
Optical Receivers
Controls/drives



TOP VIEW

Features

- High uniformity
- High gain
- High transparency resin
- Designed to meet industrial specifications
- Reference holes for precise mounting
- Reference dots for very precise mounting
- RoHS compliant

Pin Functions

No.	Name	Function
1	AE	Phototransistor A Emitter
2	CE	Phototransistor C Emitter
3	EE	Phototransistor E Emitter
4	CC	Common collector
5	FE	Phototransistor F Emitter
6	DE	Phototransistor D Emitter
7	BE	Phototransistor B Emitter
8	CC	Common collector

Ordering Information

OIT24C 6 elements monolithic SMD phototransistor

OIT24C

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Unit
T_A	Operating Temperature Range	-40	120	°C
T_S	Storage Temperature	-40	120	°C
T_{Sol}	Lead Temperature (solder) 3s		230	°C
$V_{R(BR)}$	Breakdown Voltage Collector-Emitter @ $T_A=25^\circ\text{C}$ $I_B=100\text{nA}$ $I_C=1\text{mA}$	50		V
P_D	Power Dissipation @ $T_A=25^\circ\text{C}$		150	mW

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

$T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_D	Dark Current	$V_R=10\text{V}$		5	100	nA
R_λ	Responsivity	$V_{CE}=5\text{V}$ $\lambda=800\text{nm}$	0.5	0.8		A/W
λ_p	Peak Responsivity	$V_{CE}=5\text{V}$		800		nm
$\Delta\lambda$	Spectral Bandwidth @ 50%	$V_{CE}=5\text{V}$	500		950	nm
I_{ec0}	Emitter-Collector Current	$V_{CE}=7.7\text{V}$		0.1	100	μA
I_{ce0}	Collector-Emitter Current	$V_{CE}=52\text{V}$		0.1	100	μA
H_{FE}	Gain	$V_{CC}=5\text{V}$ $I_C=2\text{mA}$	500	1000	2000	-
$V_{CE(sat)}$	Saturation Voltage	$I_E=2\text{mA}$ $I_B=20\mu\text{A}$		100	250	mV
$I_{C(on)}$	On-state Collector Current	$V_{CE}=5\text{V}$ $E_E=1.0\text{mW}/\text{cm}^2$		1		mA
ΔI_C	Interchannel variation	$V_{CE}=5\text{V}$ $E_E=1.0\text{mW}/\text{cm}^2$	-30		+30	%

AC SWITCHING CHARACTERISTICS

$T_A = 25^\circ\text{C}$ unless otherwise noted.

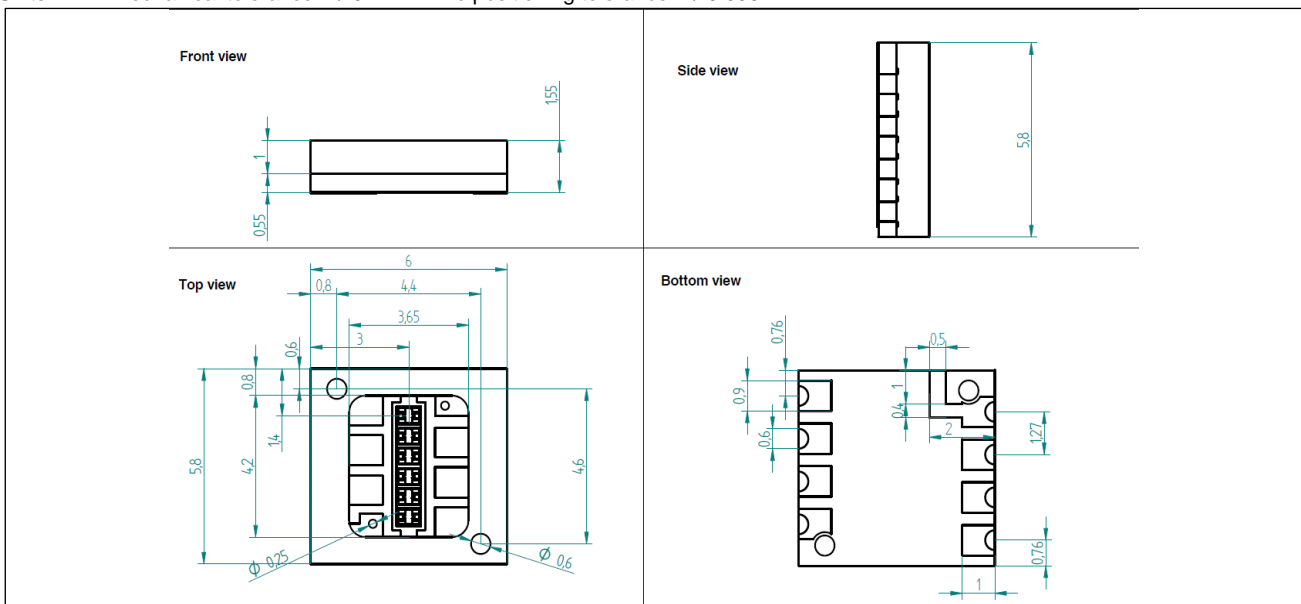
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_R	Rise Time	$V_{CC}=5\text{V}$ $I_C=1\text{mA}$ $R_L=1\text{k}\Omega$			10	μs
t_F	Fall Time	$V_{CC}=5\text{V}$ $I_C=1\text{mA}$ $R_L=1\text{k}\Omega$			10	μs

MECHANICAL CHARACTERISTICS

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
A	Phototransistor Active Area			0.09		mm^2
L	Length of the Active Area			0.2		mm
W	Width of the Active Area			0.45		mm

MECHANICAL DIMENSIONS

Units=mm Mechanical tolerance= $\pm 0.2\text{mm}$ Die positioning tolerance= $\pm 0.030\text{mm}$



TYPICAL PERFORMANCE CURVES

Figure 1 – Output voltage Vs Temperature

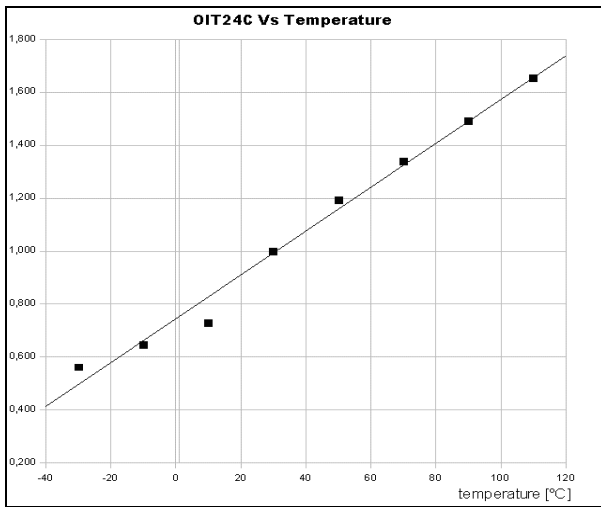


Figure 2 – Spectral Responsivity (hfe=1000)

